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Cawood

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(54) **HYBRID GROUNDING CONNECTOR**

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(58) **Field of Classification Search**

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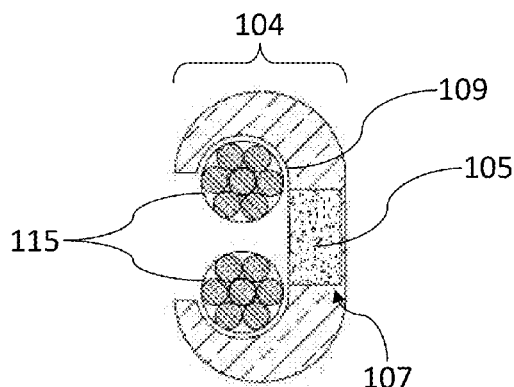
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ABSTRACT

A hybrid grounding connector is provided which combines the positive attributes of currently used connections. A recess is pre-milled, formed or extruded into the body of a compression connector and the recess is pre-filled with solder. After conductors are installed in the connector, an external heat source is applied to heat the solder until it flows into strands of the conductors and forms a solidified joint of the compression connector.

13 Claims, 3 Drawing Sheets



SECTION A-A

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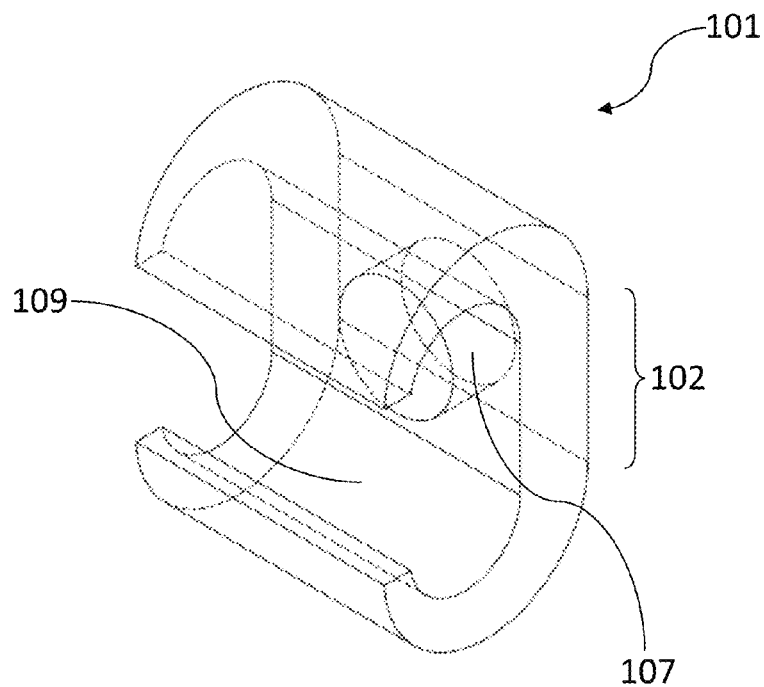


FIG. 1

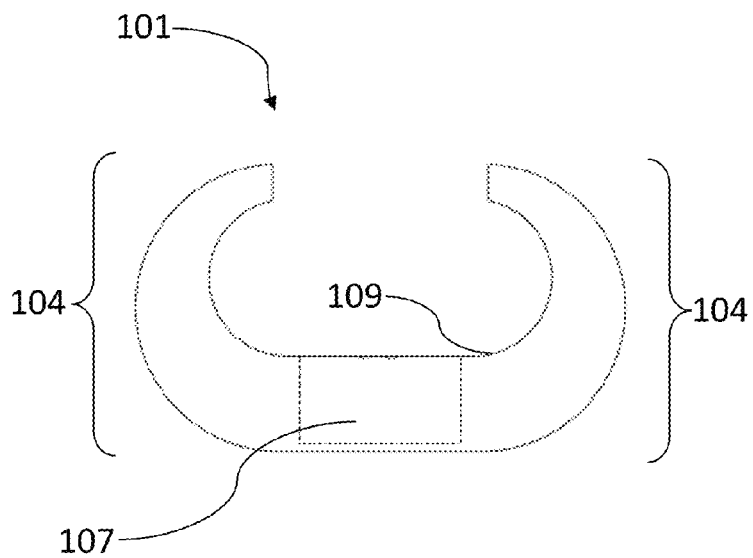


FIG. 2

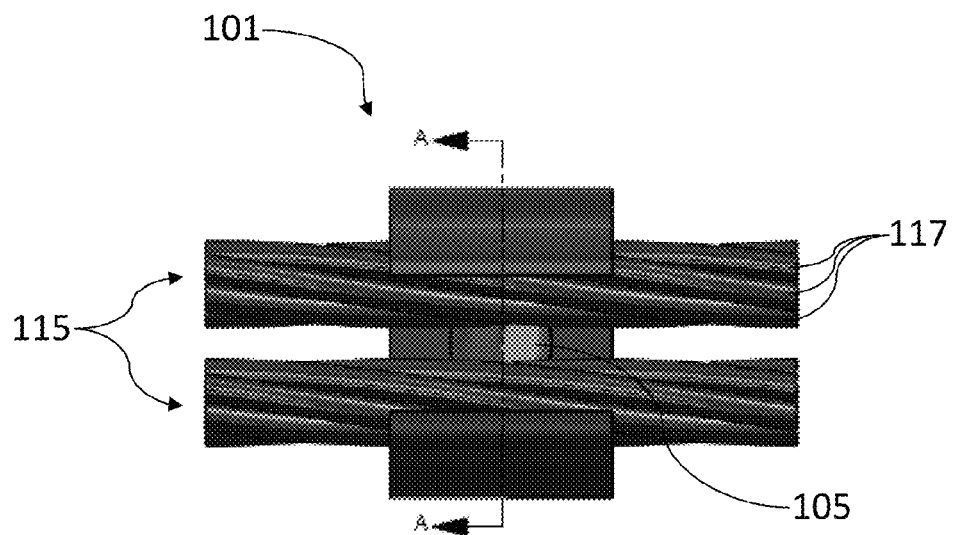


FIG. 3

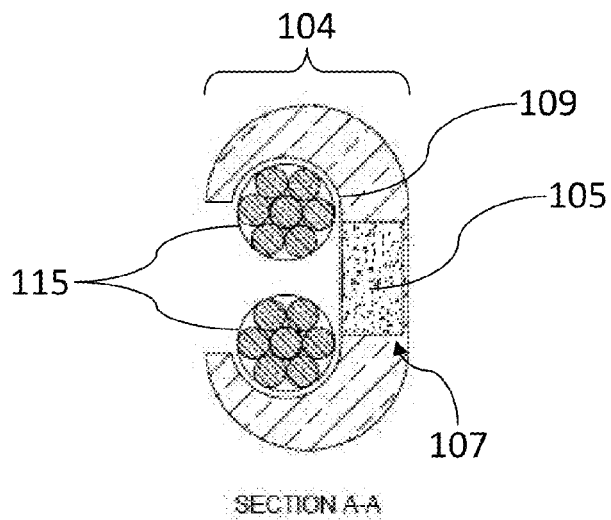


FIG. 4

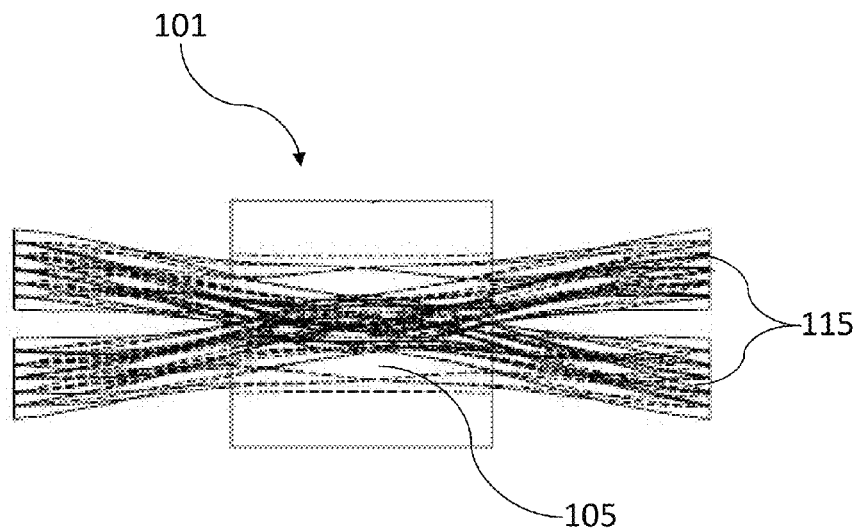


FIG. 5

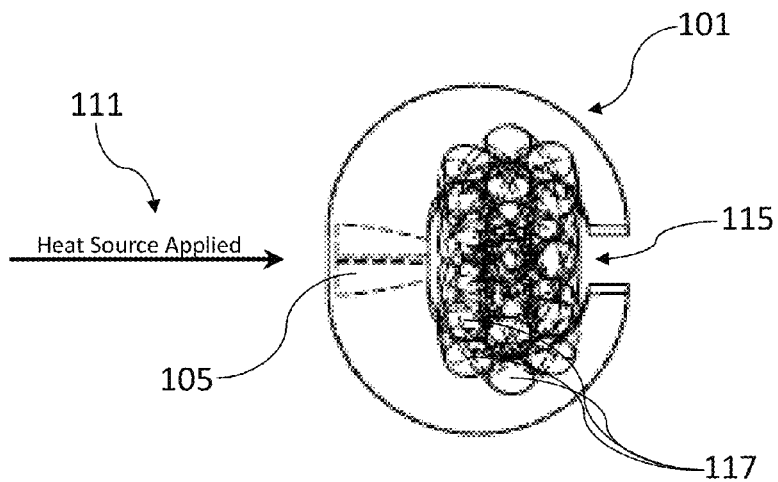


FIG. 6

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HYBRID GROUNDING CONNECTOR**FIELD OF THE INVENTION**

In general, the present invention relates to a hybrid connector for electrically grounding a plurality of conductors together. The connector comprises a recess which has been milled or formed into the body of the connector and pre-filled with solder to be heated and melted once the conductors have been installed in the connector.

BACKGROUND

There are three common methods of providing a grounding connection for a plurality of conductors. These methods include exothermic connectors, mechanical connectors and compression connectors. Each method has its own advantages and disadvantages. Exothermic connectors are believed to be the superior connection among the three mentioned methods, as it yields a solid conductor mass if the method is carried out properly. The solid joint that is produced is not susceptible to mechanical or electrical degradation. However, some disadvantages of this method include the types of tools required and the susceptibility of this method to environmental conditions such as rain or humidity. Mechanical connectors are easy to install and require no special tools for installation of conductors. However, mechanical connectors are often not preferred as a grounding method, as a tightened mechanical connector can become loose through vibrations over time which does not provide a permanent connection. Compression connectors are considered to form a permanent connection, but are believed in some instances to be inferior to exothermic connections due to small voids which can exist in the compressed joint which may allow moisture to penetrate the joint, leading to oxidation or degradation of the connection over time. Compression connectors are considered to be inferior to exothermic for resistance to fault currents. An improved connector which combines the positive attributes of the previously described methods is desired.

SUMMARY OF THE INVENTION

The present invention provides a hybrid connector for electrically grounding a plurality of conductors together. The connector comprises a recess which has been milled, extruded or formed into an interior wall of the body of the connector and pre-filled with solder. The interior walls of the connector can also be coated with flux material to promote solder flow. Conductors are installed within the connector, compressed, and an external heat source is applied which is sufficiently hot to melt the solder which is contained in the recess. The heat source remains applied until the melted solder flows into the strands of the conductors, thereby solidifying the joint of the connector.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is a front perspective view of a hybrid connector of the present invention.

FIG. 2 is a side elevation view of a hybrid connector of the present invention.

FIG. 3 is a front elevation view of a hybrid connector of the present invention being installed on a plurality of conductors.

FIG. 4 is a side elevation view of a hybrid connector of the present invention being installed on a plurality of conductors.

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FIG. 5 is a front elevation view of a hybrid connector of the present invention which has been crimped around a plurality of conductors.

FIG. 6 is a side elevation view of a hybrid connector of the present invention which has been crimped around a plurality of conductors with an external heat source applied.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENT(S)

The above and other features, aspects and advantages of the present invention will now be discussed in the following detailed description of preferred embodiments and appended claims, which are to be considered in conjunction with the accompanying drawings in which identical reference characters designate like elements throughout the views.

Shown in FIG. 1 is a front perspective view of a hybrid connector **101** for electrically grounding a plurality of conductors together. The connector **101** shown in FIG. 1 and also in FIGS. 2-6 is a compression type connector that also has attributes of an exothermic connector. FIG. 1 shows a substantially C-shaped compression type connector **101**. The connector comprises a straight portion **102** and two inwardly curved portions **104**, which are more clearly shown in FIG. 2, to form the C-shape. Milled or formed into an inner wall **109** of the connector **101** is a recess **107**. This recess **107** is pre-filled with solder during the manufacturing process of the connector **101**. It is preferred that the solder which is used to fill the recess be silver solder, but it is understood that the solder may be of any other type of solder material. FIG. 2 is a side elevation view of the hybrid connector which is shown in FIG. 1, and the recess **107** which is discussed above can be clearly seen in FIG. 2.

Shown in FIG. 3 is a front elevation view of the C-shaped hybrid compression connector **101**. In FIG. 3, it can be seen that the connector **101** has been installed on a plurality of conductors **115**, the conductors **115** being comprised themselves of a plurality of cable strands **117**. The conductors **115** fit into the curved portions **104** of the C-shaped connector **101**, as shown in FIG. 4, and contact the inner wall **109** of the connector **101** which contains the recess **107** that has been filled with solder material **105**.

Shown in FIGS. 5 and 6 are front elevation views and side elevation views, respectively, of the C-shaped hybrid compression connector **101**. In FIGS. 5 and 6, the connector **101** is shown crimped around the plurality of conductors **115**. Once the connector **101** is crimped around the conductors **115**, the resulting compressed joint could possibly contain small voids which could potentially allow moisture to penetrate the connection and lead to oxidation or degradation of the connection over time. However, the recess **107** which has been pre-filled with the solder material **105** prevents this from happening. In FIG. 6, it is shown that a heat source **111** is applied to the connector **101** in order to heat the solder material **105**. Once the solder material **105** is heated to its melting point, which is lower than the melting point of the material which the connector is comprised of, then the solder begins to flow into the strands **117** of the conductors **115**. The heat source **111** remains applied until the solder **105** is fully melted and integrated into the strands **117** of the conductors **115**, resulting in a solid conductor mass.

Although the invention has been described in detail above, it is expressly understood that it will be apparent to persons skilled in the relevant art that the invention may be modified without departing from the spirit of the invention. Various changes of form, design, or arrangement may be made to the invention without departing from the spirit and scope of the

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invention. Therefore, the above mentioned description is to be considered exemplary, rather than limiting, and the true scope of the invention is that defined in the following claims.

What is claimed is:

1. A hybrid compression connector for providing a ground-
ing connection, the connector comprising:
a compression connector for receiving a plurality of con-
ductors which are comprised of multiple strands;
wherein an interior wall of the compression connector
comprises a recess filled, at least partially, with solder; 10
and
wherein after the compression connector has been crimped
around the conductors, a heat source is applied to melt
the solder until it flows into the strands of the conductors
to solidify the connection and prevent moisture intru- 15
sion.
2. The hybrid compression connector of claim 1, wherein
the interior walls of the compression connector have a coating
of flux which has been pre-applied to them.
3. The hybrid compression connector of claim 1, wherein 20
the solder which at least partially fills the recess is silver
solder.
4. The hybrid compression connector of claim 1, wherein,
prior to the heat source being applied, the solder remains in
the recess by friction fit or by being soldered into position. 25
5. The hybrid compression connector of claim 1, wherein
the material which is used to form the connector has a higher
melting point than that of the solder which at least partially
fills the recess.
6. The hybrid compression connector of claim 1, wherein 30
the connector is substantially C-shaped and comprises a wall
which forms a straight portion and walls which form two
opposite and inwardly curved portions to form the C-shape
and wherein an interior wall of the straight portion of the
connector comprises the recess filled, at least partially, with 35
solder.

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7. A method for providing a grounding connection using a
hybrid grounding connector, comprising the steps of:
milling, forming or extruding a recess into an inner wall of
the connector;
filling the recess, at least partially, with solder;
placing a plurality of conductors which are comprised of
multiples strands in the connector;
crimping or tightening the connector around the plurality
of conductors until the conductors are secure; and
applying an external heat source to the connector in order
to melt the solder to allow it to flow into the strands of the
conductors, thereby solidifying the connection and pre-
venting moisture intrusion.
8. The method of claim 7, wherein the connector is a
compression connector.
9. The method of claim 7, wherein the connector is a
substantially C-shaped compression connector and com-
prises a wall which forms a straight portion and walls which
form two opposite and inwardly curved portions to form the
C-shape and wherein an interior wall of the straight portion of
the connector comprises the recess filled, at least partially,
with solder.
10. The method of claim 7, wherein all interior walls of the
connector which contact the conductors have a coating of flux
which has been pre-applied to them.
11. The method of claim 7, wherein the material which is
used to form the connector has a higher melting point than
that of the solder which at least partially fills the recess.
12. The method of claim 7, wherein the solder which at
least partially fills the recess is silver solder.
13. The method of claim 7, wherein, prior to the heat source
being applied, the solder remains in the recess by friction fit or
by being soldered into position.

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